## DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

RESIN RECYCLING SYSTEM

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the	specification	of	which	(check	one)
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(x) is attached hereto.
( ) was filed by an authorized person on my behalf on

as Application Serial No. \_\_\_\_\_\_

and was amended on \_\_\_\_\_\_(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims as amended by any amendment referred to above.

I wacknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, \$119 of any foreign application(s) for patent or inventor's certificate listed below and so identified, and I have also identified below any foreign application for patent or inventor's certificate on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed.

Number	Country	Day/Month/Year Filed	Claimed (Yes or No)
2000-174306	Japan	9/6/2000	No
2000-256202	Japan	25/8/2000	Yes
$2\ 0\ 0\ 0\ -\ 2\ 5\ 6\ 4\ 2\ 2$	Japan	25/8/2000	No
2001-047750	Japan	23/2/2001	Yes
2001-076791	Japan	16/3/2001	No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.

Filing Date

Status

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorneys, with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith and request that all correspondence in respect to this application be directed to FITCH, EVEN, TABIN & FLANNERY, Suite 900, 135 South LaSalle Street, Chicago, Illinois 60603-4277, Telephone No. (312) 372-7842:

Attorney	Reg. No.	Attorney	Reg. No.
Morgan L. Fitch, Jr. Francis A. Even Julius Tabin John F. Flannery Robert B. Jones James J. Schumann R. Steven Pinkstaff James J. Hamill Timothy E. Levstik Joseph E. Shipley Bryant R. Gold	17,023 16,880 16,754 19,759 20,135 20,856 20,448 19,958 30,192 31,137 29,715	Robert J. Fox Kenneth H. Samples Philip T. Petti John S. Paniaguas Donald A. Peterson James R. McBride James A. Sprowl Bruce R. Mansfield Richard P. Beem Richard A. Kaba Karl R. Fink	27,635 25,747 31,651 31,051 18,647 24,275 25,061 29,086 32,961 30,562 34,161
Full name of sole or one Joint inventor:  Inventor's signature:  Jakuttral man			
Date:	Augus	st 20, 2001	
Residence:	(City	yo, Japan and State for U.S. Res and Country for others	
Post Office Address:	c/o Techno	Polymer Co., Ltd., 1-18-1, Kyobashi, Chuo-k	u, Tokyo 104-0031, Japan
Citizenship:	Japan		

Address for Correspondence: FITCH, EVEN, TABIN & FLANNERY 135 South LaSalle Street-Suite 900 Chicago, Illinois 60603-4277

or contract the contract to th	
Full name of sole or one joint inventor:	Kenichi URABE
•	Ckenichi Onabe
Inventor's signature:	
Date:	August 20, 2001
Residence:	Tokyo, Japan
	(City and State for U.S. Residents; City and Country for others);
Post Office Address:	
	c/o Techno Polymer Co., Ltd., 1-18-1, Kyobashi, Chuo-ku, Tokyo 104-0031, Japan
Citizenship:	Japan.
1004	
Full name of sole or one joint inventor:	Kouji ISHIKAWA
*:1 *:2	L STEWARD
Inventor's signature:	Kouji ISHIKAWA
Dates	August 20, 2001
Residence:	Tokyo, Japan
C)	(City and State for U.S. Residents; City and Country for others);
Post Office Address:	
10年	c/o Techno Polymer Co., Ltd., 1-18-1, Kyobashi, Chuo-ku, Tokyo 104-0031, Japan
Citizenship:	Japan
Full name of sole or one joint inventor:	
Inventor's signature:	
Date:	
Residence:	
	(City and State for U.S. Residents; City and Country for others);
Post Office Address:	
Citizenship:	